

Crownpo Technology

Power MOSFET

Features

- · Robust High Voltage Termination
- · Avalanche Energy Specified

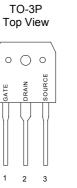
Pin Configuration

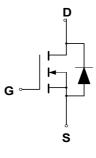
- Source-to-Drain Diode Recovery Time Comparable to a Discrete Fast Recovery Diode
- · Diode is Characterized for Use in Bridge Circuits
- I_{DSS} and $V_{DS(\text{on})}$ Specified at Elevated Temperature

General Description

This high voltage MOSFET uses an advanced termination scheme to provide enhanced voltage-blocking capability without degrading performance over time. In addition, this advanced MOSFET is designed to withstand high energy in avalanche and commutation modes. The new energy efficient design also offers a drain-to-source diode with a fast recovery time. Designed for high voltage, high speed switching applications in power supplies, converters and PWM motor controls, these devices are particularly well suited for bridge circuits where diode speed and commutating safe operating areas are critical and offer additional and safety margin against unexpected voltage transients.

Symbol





N-Channel MOSFET

Absolute Maximum Ratings

Rating	Symbol	Value	Unit
Drain to Current - Continuous	I _D	14	Α
- Pulsed	I _{DM}	56	
Gate-to-Source Voltage - Continuous	V_{GS}	±20	V
- Non-repetitive	V_{GSM}	±40	V
Total Power Dissipation	PD	190	W
Derate above 25°C		1.5	W/°C
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to 150	°C
Single Pulse Drain-to-Source Avalanche Energy $- T_J = 25^{\circ}C$	E _{AS}	760	mJ
$(V_{DD} = 100V, V_{GS} = 10V, I_{L} = 20A, L = 10mH, R_{G} = 25Ohm)$			
Thermal Resistance - Junction to Case	Rthuc	0.65	°C/W
- Junction to Ambient	Rthja	40	
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds	T∟	260	



Ordering Information

Part Number	Package		
CTM14N50N3P	TO-3P		

Electrical Characteristics

Unless otherwise specified, $T_J = 25^{\circ}C$

				CTM14N50		
Characteristic	Symbol	Min	Тур	Мах	Units	
Drain-Source Breakdown Voltage	V _{(BR)DSS}	500			V	
$(V_{GS} = 0 V, I_{D} = 250 \mu A)$						
Drain-Source Leakage Current	I _{DSS}				μA	
$(V_{DS} = 500 \text{ V}, V_{GS} = 0 \text{ V})$					25	
$(V_{DS} = 400 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125^{\circ}$	C)				250	
Gate-Source Leakage Current-Forward		I _{GSSF}			100	nA
$(V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V})$						
Gate-Source Leakage Current-Reve	I _{GSSR}			-100	nA	
$(V_{GS} = -20V, V_{DS} = 0V)$						
Gate Threshold Voltage		V _{GS(th)}	2.0		4.0	V
$(V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A})$						
Static Drain-Source On-Resistance (R _{DS(on)}			0.4	Ohm	
Drain-Source On-Voltage (V_{GS} = 10 V	$V_{\text{DS(on)}}$			7.5	V	
Forward Transconductance (V _{DS} = 1	g fs	7.8			S	
Input Capacitance	$(V_{DS} = 25 V, V_{GS} = 0 V,$	C _{iss}		2038		pF
Output Capacitance	f = 1.0 MHz	C _{oss}		307		pF
Reverse Transfer Capacitance	1 – 1.0 WHZ)	C _{rss}		10		pF
Turn-On Delay Time		t _{d(on)}		15		ns
Rise Time	$(V_{DD} = 250 \text{ V}, I_D = 14 \text{ A},$	tr		36		ns
Turn-Off Delay Time	R _D = 170hm, R _G = 6.20hm) *	t _{d(off)}		35		ns
Fall Time		t _f		29		ns
Total Gate Charge	(V _{DS} = 400 V, I _D = 14 A,	Qg			64	nC
Gate-Source Charge	$(V_{DS} = 400 V, I_D = 14 A, V_{GS} = 10 V)^*$	Q _{gs}			16	nC
Gate-Drain Charge	$v_{GS} = 10 v$)	Q_{gd}			26	nC
Internal Drain Inductance	L _D		5.0		nH	
(Measured from the drain lead 0.2	5" from package to center of die)					
Internal Source Inductance	Ls		13		nH	
(Measured from the source lead 0	.25" from package to source bond pad)					
SOURCE-DRAIN DIODE CHARACT	TERISTICS					
Forward On-Voltage(1)	$(I_{\rm S} = 14 \text{ A}, V_{\rm GS} = 0 \text{ V},$	V _{SD}			1.4	V
Forward Turn-On Time	(- , ,	t _{on}		**		ns
Reverse Recovery Time	$d_{IS}/d_t = 100A/\mu s)$	trr		487	731	ns

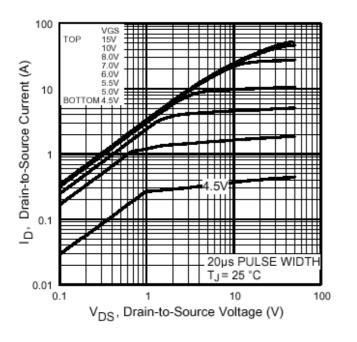
* Pulse Test: Pulse Width <=300µs, Duty Cycle <= 2%

** Negligible, Dominated by circuit inductance



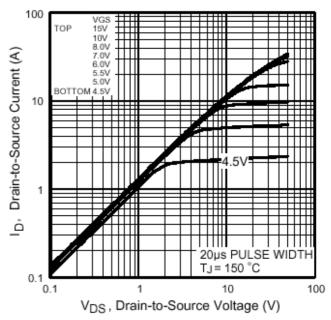


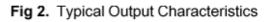
Crownpo Technology



Typical Electrical Characteristics

Fig 1. Typical Output Characteristics





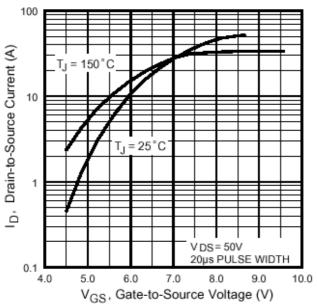
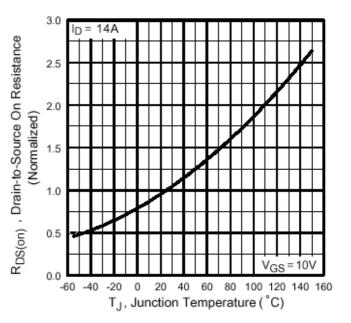
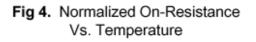


Fig 3. Typical Transfer Characteristics







Crownpo Technology

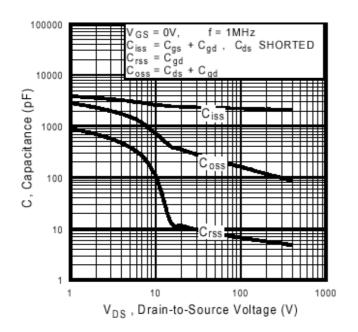
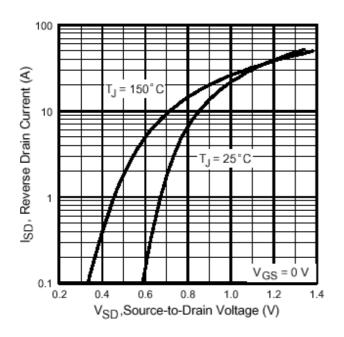
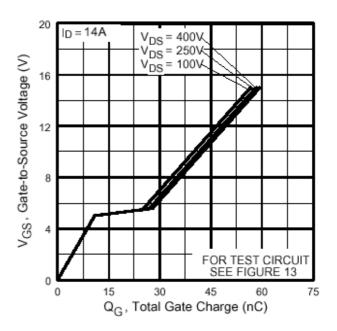


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage









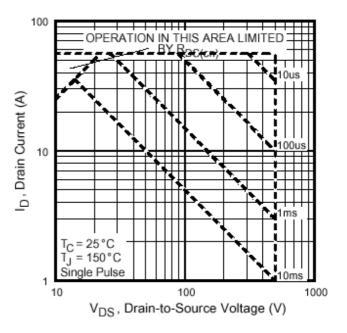
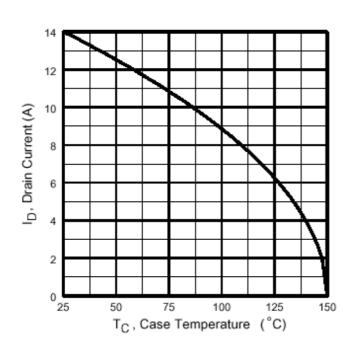


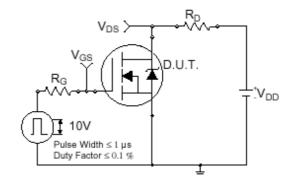
Fig 8. Maximum Safe Operating Area

Crownpo Technology

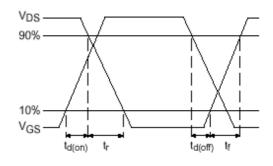


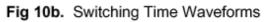












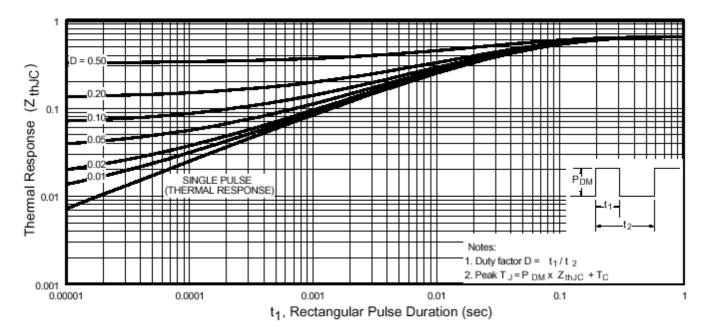


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

Crownpo Technology

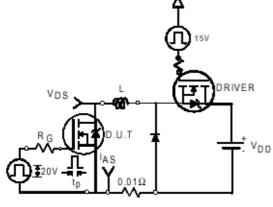


Fig 12a. Unclamped Inductive Test Circuit

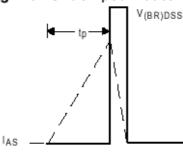
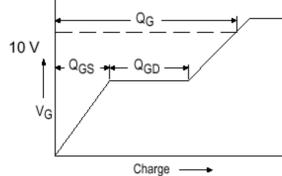


Fig 12b. |Unclamped Inductive Waveforms





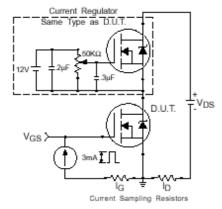


Fig 13b. Gate Charge Test Circuit

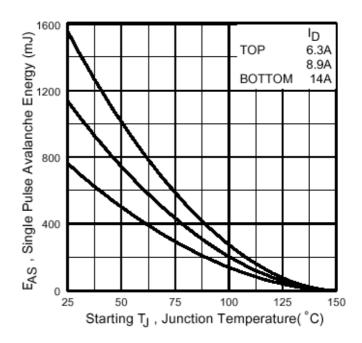
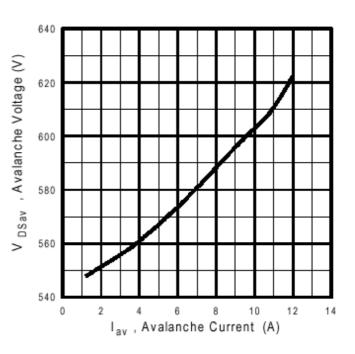
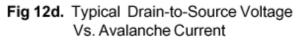


Fig 12c. Maximum Avalanche Energy Vs. Drain Current



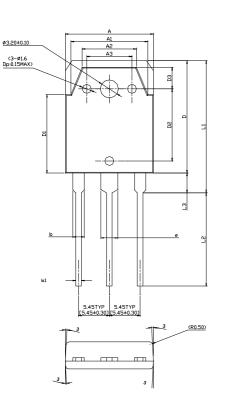


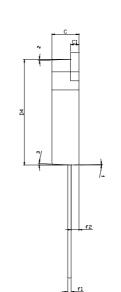
23-Aug-04 Document No. 51228



Crownpo Technology

Package Dimension





	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHS		
SYMBOLS	MIN	NOM	MAX	MIN NOM		MAX
Α	15.40		15.80	0.606		0.622
A1	13.40		13.80	0.527		0.543
A2	9.40		9.80	0.370		0.386
A3		8.00			0.315	
b	1.80		2.20	0.071		0.087
b1	0.80		1.20	0.031		0.047
С	4.60		5.00	0.181		0.197
C1	1.45		1.65	0.057		0.065
D	19.70		20.10	0.775		0.791
D1	13.70		14.10	0.539		0.555
D2	12.56		12.96	0.494		0.510
D3	3.60		4.00	0.142		0.157
D4	18.50		18.90	0.728		0.744
е	2.80		3.20	0.110		0.126
f1	0.55		0.75	0.021		0.029
f2	1.20		1.60	0.047		0.063
L1	23.20		23.60	0.913		0.929
L2	16.20		16.80	0.638		0.661
L3	3.30		3.70	0.130		0.146
1		1°			1°	
2		2°			2•	
3		3°			3.	

TO-3P